

查询"2141-2B"供应商

# EMM 2141

## SEMI 2141 120NSEC, STATIC, TTL IN/OUT 4096 x 1 N-MOS RAM

### FEATURES

- Industry Standard 2147 Pinout
- Completely Static Memory — No Clock or Timing Strobe Required
- Equal Access and Cycle Times
- Single +5V Supply
- Automatic Power-Down
- Directly TTL Compatible — All Inputs and Output
- Separate Data Input and Output
- Three-State Output
- Standard 18-Pin Package

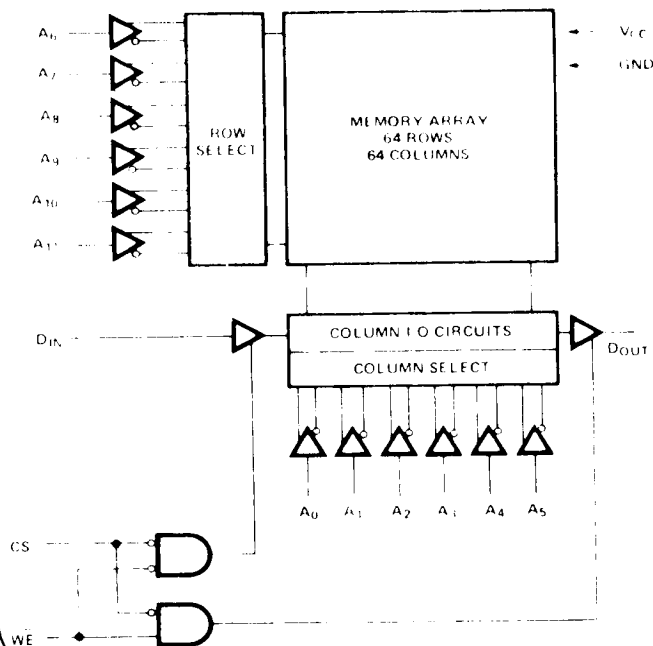
### GENERAL DESCRIPTION

The EMM SEMI 2141 is a 4096-bit static Random Access Memory organized as 4096 words by 1-bit using N-MOS, a high-performance technology. It uses a unique design approach which provides the ease-of-use features associated with non-clocked static memories and the reduced standby power dissipation associated with clocked static memories. To the user this means low standby power dissipation without the need for clocks, address setup and hold times, nor reduced data rates due to cycle times that are longer than access times.

$\overline{CS}$  controls the power-down feature. In less than a cycle time after  $\overline{CS}$  goes high—deselecting the 2141—the part automatically reduces its power requirements and remains in this low power standby mode as long as  $\overline{CS}$  remains high. This device feature results in system power savings as great as 85% in larger systems, where the majority of devices are deselected.

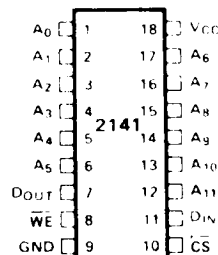
The 2141 is placed in an 18-pin package configured with the industry standard pinout, the same as the 2147. It is directly TTL compatible in all respects: inputs, outputs, and a single +5V supply. The data is read out nondestructively and has the same polarity as the input data. A data input and a separate three-state output are used.

### BLOCK DIAGRAM

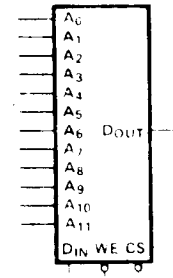


### PIN CONFIGURATION AND LOGIC SYMBOL

#### PIN CONFIGURATION



#### LOGIC SYMBOL



#### PIN NAMES

|                                  |                |     |             |
|----------------------------------|----------------|-----|-------------|
| A <sub>0</sub> - A <sub>11</sub> | ADDRESS INPUTS | VCC | POWER (+5V) |
| $\overline{WE}$                  | WRITE ENABLE   | GND | GROUND      |
| $\overline{CS}$                  | CHIP SELECT    |     |             |
| D <sub>IN</sub>                  | DATA INPUT     |     |             |
| D <sub>OUT</sub>                 | DATA OUTPUT    |     |             |

#### TRUTH TABLE

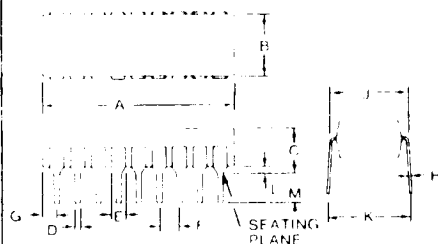
| CS | WE | MODE         | OUTPUT | POWER   |
|----|----|--------------|--------|---------|
| H  | X  | NOT SELECTED | HIGH Z | STANDBY |
| L  | L  | WRITE        | HIGH Z | ACTIVE  |
| L  | H  | READ         | DOUT   | ACTIVE  |

**EMM** SEMI, INC.

A Subsidiary of Electronic Memories & Magnetics Corporation • 2000 West 14 Street, Tempe, Arizona 85281 • (602) 968-4431

|                        | 2141-2 | 2141-3 | 2141-4 | 2141-5 | L2141-3 | L2141-4 | L2141-5 |
|------------------------|--------|--------|--------|--------|---------|---------|---------|
| Access/Cycle Time (ns) | 120    | 150    | 200    | 250    | 150     | 200     | 250     |
| Operating Current (mA) | 70     | 70     | 55     | 55     | 40      | 40      | 40      |
| Standby Current (mA)   | 20     | 20     | 12     | 12     | 5       | 5       | 5       |

## TYPICAL OUTLINE DRAWING



## PACKAGING DIMENSIONS

| DIM | B PLASTIC PACKAGE |        |        |       | A CERAMIC PACKAGE |          |        |           | E CERDIP PACKAGE |        |        |       |
|-----|-------------------|--------|--------|-------|-------------------|----------|--------|-----------|------------------|--------|--------|-------|
|     | MILLIMETERS       |        | INCHES |       | MILLIMETERS       |          | INCHES |           | MILLIMETERS      |        | INCHES |       |
|     | MIN               | MAX    | MIN    | MAX   | MIN               | MAX      | MIN    | MAX       | MIN              | MAX    | MIN    | MAX   |
| A   | 21.540            | 23.622 | 0.850  | 0.930 | 22.606            | 23.114   | 0.890  | 0.910     | 27.400           | 28.100 | 1.075  | 1.105 |
| B   | 6.096             | 7.493  | 0.240  | 0.295 | 7.061             | 7.569    | 0.278  | 0.298     | —                | —      | —      | —     |
| C   | —                 | —      | —      | 0.110 | —                 | 4.826    | —      | 0.190     | —                | 4.76   | —      | 0.188 |
| D   | 0.381             | 0.584  | 0.015  | 0.023 | 0.381             | 0.584    | 0.015  | 0.023     | 0.381            | 0.584  | 0.015  | 0.023 |
| E   | 1.143             | 1.778  | 0.045  | 0.070 | 1.016             | 1.778    | 0.040  | 0.070     | 1.143            | 1.651  | 0.045  | 0.065 |
| F   | 2.286             | 2.794  | 0.090  | 0.110 | 2.286             | 2.794    | 0.090  | 0.110     | 2.286            | 2.794  | 0.090  | 0.110 |
| G   | 0.635             | 1.159  | 0.025  | 0.085 | 0.762             | 1.778    | 0.030  | 0.070     | 0.381            | 1.210  | 0.015  | 0.080 |
| H   | 0.203             | 0.305  | 0.008  | 0.012 | 0.203             | 0.405    | 0.008  | 0.012     | 0.203            | 0.305  | 0.008  | 0.012 |
| J   | 7.366             | 8.255  | 0.290  | 0.325 | 7.620             | 8.077    | 0.300  | 0.318     | 7.620            | 8.128  | 0.299  | 0.320 |
| K   | 7.366             | 10.414 | 0.290  | 0.410 | —                 | 6.20 REF | —      | 0.300 REF | 8.255            | 9.906  | 0.325  | 0.390 |
| L   | 0.508             | 1.278  | 0.020  | 0.050 | 0.635             | 1.651    | 0.025  | 0.065     | 0.381            | 1.216  | 0.015  | 0.045 |
| M   | 2.540             | 4.191  | 0.100  | 0.165 | 2.540             | 3.810    | 0.100  | 0.150     | 2.540            | 3.810  | 0.100  | 0.150 |

### WARNING:

#### MOS CIRCUITS ARE SUBJECT TO DAMAGE FROM STATIC DISCHARGE

Internal static discharge circuits are provided to minimize part damage due to environmental static electrical charge build-up. Industry established recommendations for handling MOS circuits include:

1. Ship and store product in conductive shipping tubes or in conductive foam plastic. Never ship or store product in non-conductive plastic containers or non-conductive plastic foam material.
2. Handle MOS parts only at conductive work stations.
3. Ground all assembly and repair tools.

Represented in your area by:

EMM SEMI reserves the right to make changes at any time in order to improve design and to supply the best product possible.

The information contained in this data sheet is considered accurate and reliable at this time. However, no responsibility is assumed by EMM SEMI, Inc. for its use, nor for any infringements of patents or pending applications, or the rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent right by EMM SEMI, Inc.

# EMM SEMI, INC.

A Subsidiary of Electronic Memories & Magnetics Corporation  
2000 West 14 Street, Tempe, Arizona 85281  
Telephone (602) 968-4431

ORIGINAL

PUBLISHED IN U.S.A. JUNE 1979

2